

M5M51008BFP,VP,RV,KV,KR -70VL,-10VL,-12VL,-15VL, -70VLL,-10VLL,-12VLL,-15VLL

1048576-BIT(131072-WORD BY 8-BIT)CMOS STATIC RAM

DESCRIPTION

The M5M51008BFP,VP,RV,KV,KR are a 1048576-bit CMOS static RAM organized as 131072 word by 8-bit which are fabricated using high-performance triple polysilicon CMOS technology. The use of resistive load NMOS cells and CMOS periphery result in a high density and low power static RAM.

They are low standby current and low operation current and ideal for the battery back-up application.

The M5M51008BVP,RV,KV,KR are packaged in a 32-pin thin small outline package which is a high reliability and high density surface mount device(SMD).Two types of devices are available.

VP,KV(normal lead bend type package),RV,KR(reverse lead bend type package). Using both types of devices, it becomes very easy to design a printed circuit board.

FEATURES

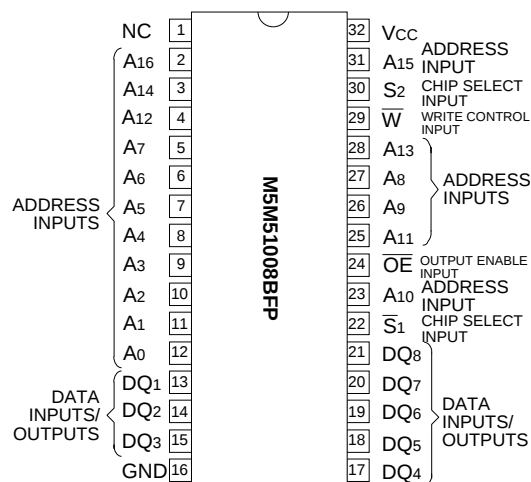
Type name	Access time (max)	Vcc	Power supply current	
			Active (1MHz) (max)	stand-by (max)
M5M51008BFP,VP,RV,KV,KR-70VL	70ns	3.3±0.3V	10mA	60µA
M5M51008BFP,VP,RV,KV,KR-10VL	100ns			
M5M51008BFP,VP,RV,KV,KR-12VL	120ns			
M5M51008BFP,VP,RV,KV,KR-15VL	150ns	3.0±0.3V	10mA	55µA
M5M51008BFP,VP,RV,KV,KR-70VLL	70ns			
M5M51008BFP,VP,RV,KV,KR-10VLL	100ns			
M5M51008BFP,VP,RV,KV,KR-12VLL	120ns	3.0±0.3V	10mA	11µA
M5M51008BFP,VP,RV,KV,KR-15VLL	150ns			

- Low stand-by current 0.3µA (typ.)
- Directly TTL compatible : All inputs and outputs
- Easy memory expansion and power down by $\overline{S}_1, S_2$
- Data hold on +2V power supply
- Three-state outputs : OR - tie capability
- OE prevents data contention in the I/O bus
- Common data I/O
- Package
 - M5M51008BFP 32pin 525mil SOP
 - M5M51008BVP,RV 32pin 8 X 20 mm² TSOP
 - M5M51008BKV,KR 32pin 8 X 13.4 mm² TSOP

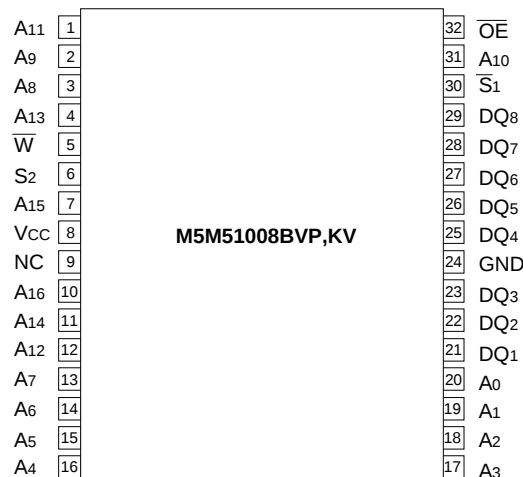
APPLICATION

Small capacity memory units

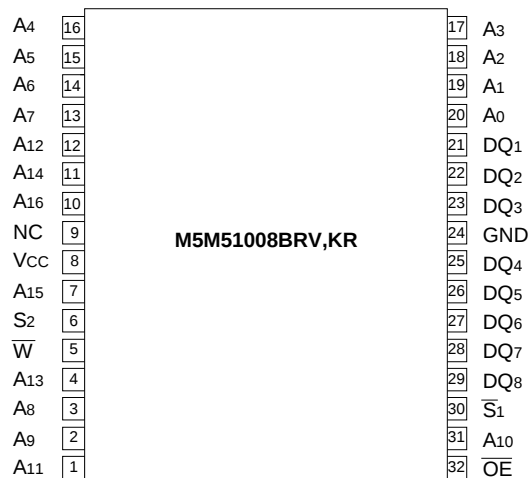
PIN CONFIGURATION (TOP VIEW)



Outline 32P2M-A



Outline 32P3H-E(VP), 32P3K-B(KV)



Outline 32P3H-F(RV), 32P3K-C(KR)

NC : NO CONNECTION

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FUNCTION

The operation mode of the M5M51008B series are determined by a combination of the device control inputs $\bar{S}_1$, S_2 , $\bar{W}$ and $\bar{OE}$.

Each mode is summarized in the function table.

A write cycle is executed whenever the low level $\bar{W}$ overlaps with the low level $\bar{S}_1$ and the high level S_2 . The address must be set up before the write cycle and must be stable during the entire cycle. The data is latched into a cell on the trailing edge of $\bar{W}$, $\bar{S}_1$ or S_2 , whichever occurs first, requiring the set-up and hold time relative to these edge to be maintained. The output enable input $\bar{OE}$ directly controls the output stage. Setting the $\bar{OE}$ at a high level, the output stage is in a high-impedance state, and the data bus contention problem in the write cycle is eliminated.

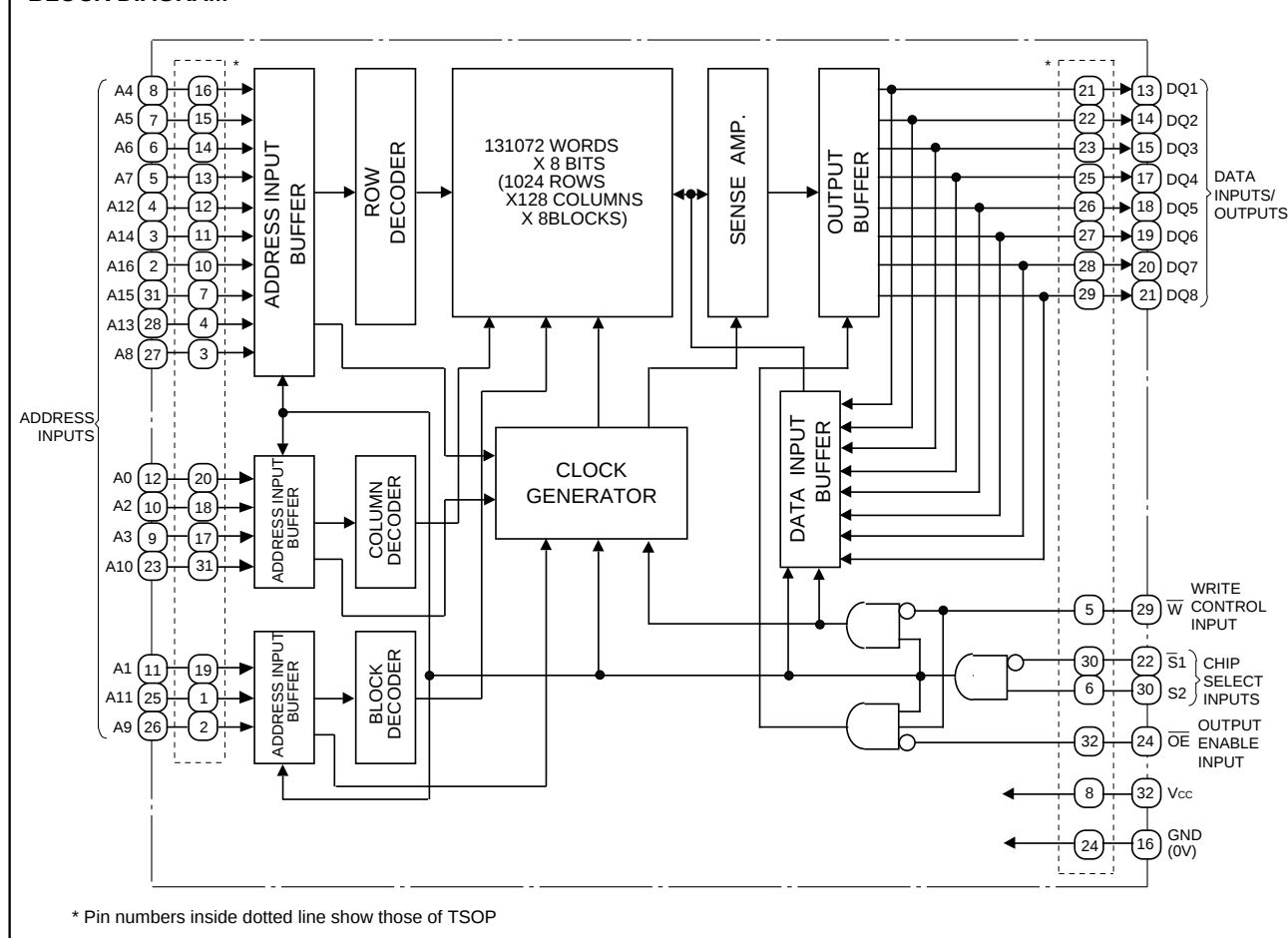
A read cycle is executed by setting $\bar{W}$ at a high level and $\bar{OE}$ at a low level while $\bar{S}_1$ and S_2 are in an active state ($\bar{S}_1=L, S_2=H$).

When setting $\bar{S}_1$ at a high level or S_2 at a low level, the chip are in a non-selectable mode in which both reading and writing are disabled. In this mode, the output stage is in a high-impedance state, allowing OR-tie with other chips and memory expansion by $\bar{S}_1$ and S_2 . The power supply current is reduced as low as the stand-by current which is specified as I_{cc3} or I_{cc4} , and the memory data can be held at +2V power supply, enabling battery back-up operation during power failure or power-down operation in the non-selected mode.

FUNCTION TABLE

$\bar{S}_1$	S_2	$\bar{W}$	$\bar{OE}$	Mode	DQ	I_{cc}
X	L	X	X	Non selection	High-impedance	Stand-by
H	X	X	X	Non selection	High-impedance	Stand-by
L	H	L	X	Write	Din	Active
L	H	H	L	Read	Dout	Active
L	H	H	H		High-impedance	Active

BLOCK DIAGRAM



M5M51008BFP,VP,RV,KV,KR -70VL,-10VL,-12VL,-15VL, -70VLL,-10VLL,-12VLL,-15VLL

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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
V _{cc}	Supply voltage	With respect to GND	- 0.3*-4.6	V
V _I	Input voltage		- 0.3*-V _{cc} + 0.3 (Max 4.6)	V
V _O	Output voltage		0-V _{cc}	V
P _d	Power dissipation	T _a =25°C	700	mW
T _{opr}	Operating temperature		0-70	°C
T _{stg}	Storage temperature		- 65-150	°C

* -3.0V in case of AC (Pulse width £ 30ns)

DC ELECTRICAL CHARACTERISTICS (T_a=0-70°C, unless otherwise noted)

Symbol	Parameter	Test conditions		Limits						Unit
				-70VL, -70VLL -10VL, -10VLL			-12VL, -12VLL -15VL, -15VLL			
				V _{CC} =3.3±0.3V			V _{CC} =3.0±0.3V			
				Min	Typ	Max	Min	Typ	Max	
V _{IH}	High-level input voltage			2.0		V _{CC} +0.3V	2.0		V _{CC} +0.3V	V
V _{IL}	Low-level input voltage			-0.3		0.6	-0.3		0.6	V
V _{OH1}	High-level output voltage 1	I _{OH} = -0.5mA		2.4			2.4			V
V _{OH2}	High-level output voltage 2	I _{OH} = -0.05mA		V _{CC} -0.5V			V _{CC} -0.5V			V
V _{OL}	Low-level output voltage	I _{OL} =2mA				0.4			0.4	V
I _I	Input current	V _I =0~V _{CC}				±1			±1	µA
I _O	Output current in off-state	$\overline{S}_1$ =V _{IH} or S ₂ =V _{IL} or OE=V _{IH} V _{IO} =0~V _{CC}				±1			±1	µA
I _{CC1}	Active supply current (Min cycle)	$\overline{S}_1$ =V _{IL} , S ₂ =V _{IH} , other inputs=V _{IH} or V _{IL}		20	35		15	30	mA	
I _{CC2}	Active supply current (1MHz)	Output-open(duty 100%)		3	10		3	10		
I _{CC3}	Stand-by current	1) S ₂ ≤ 0.2V 2) $\overline{S}_1$ ≥ V _{CC} -0.2V, S ₂ ≥ V _{CC} -0.2V other inputs=0~V _{CC}	-L		60			55	µA	
			-LL		12			11		
I _{CC4}	Stand-by current	$\overline{S}_1$ =V _{IH} or S ₂ =V _{IL} , other inputs=0~V _{CC}			0.33			0.33	mA	

* -3.0V in case of AC (Pulse width £ 30ns)

CAPACITANCE (T_a=0-70°C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
C _I	Input capacitance	V _I =GND, V _I =25mVrms, f=1MHz			6	pF
C _O	Output capacitance	V _O =GND, V _O =25mVrms, f=1MHz			8	pF

Note 1: Direction for current flowing into an IC is positive (no mark).

2: Typical value is V_{cc} = 3V, T_a = 25°C

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(1) MEASUREMENT CONDITIONS

 $3.0 \pm 0.3V(-12VL, -12VLL, -15VL, -15VLL)$

Input rise and fall time 5ns

Reference level $V_{OH}=V_{OL}=1.5V$

Output loads Fig.1, $C_L=100\text{pF}$ (-15VL,-15VLL,)

$C_L=30\text{pF}$ (-70VL,-10VL,12VL,-70VLL,-10VLL,12VLL)

 $C_L = 5 \text{ pF}$ (for $t_{\text{en}}, t_{\text{dis}}$)

Transition is measured $\pm 500\text{mV}$ from steady

state voltage. (for ten,tdis)

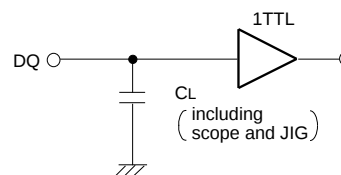


Fig.1 Output load

Symbol	Parameter	Limits								Unit
		-70VL,VLL		-10VL,VLL		-12VL,VLL		-15VL,VLL		
		Min	Max	Min	Max	Min	Max	Min	Max	
tCR	Read cycle time	70		100		120		150		ns
ta(A)	Address access time		70		100		120		150	ns
ta(S1)	Chip select 1 access time		70		100		120		150	ns
ta(S2)	Chip select 2 access time		70		100		120		150	ns
ta(OE)	Output enable access time		35		50		60		75	ns
tdis(S1)	Output disable time after $\overline{S_1}$ high		25		35		40		50	ns
tdis(S2)	Output disable time after S_2 low		25		35		40		50	ns
tdis(OE)	Output disable time after $\overline{OE}$ high		25		35		40		50	ns
ten(S1)	Output enable time after $\overline{S_1}$ low	10		10		10		10		ns
ten(S2)	Output enable time after S_2 high	10		10		10		10		ns
ten(OE)	Output enable time after $\overline{OE}$ low	5		5		5		5		ns
tv(A)	Data valid time after address	10		10		10		10		ns

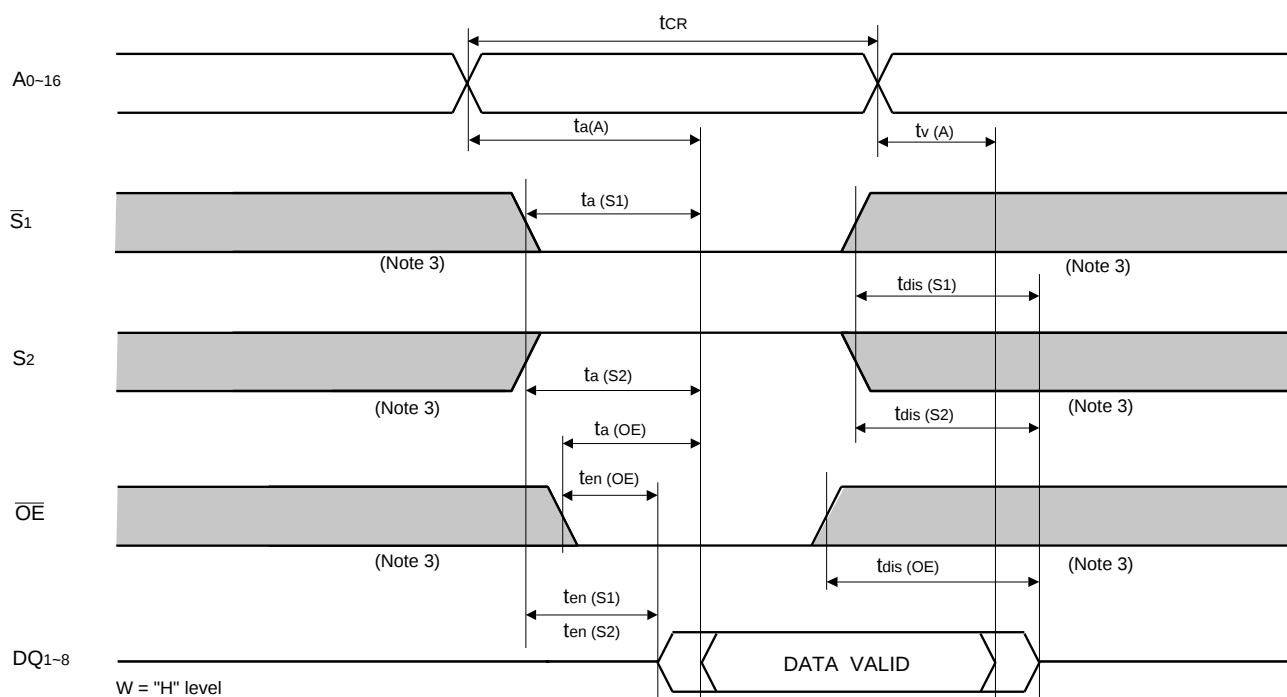
Symbol	Parameter	Limits								Unit
		-70VL,VLL		-10VL,VLL		-12VL,VLL		-15VL,VLL		
		Min	Max	Min	Max	Min	Max	Min	Max	
t _{cw}	Write cycle time	70		100		120		150		ns
t _{w(W)}	Write pulse width	55		75		85		100		ns
t _{su(A)}	Address setup time	0		0		0		0		ns
t _{su(A-WH)}	Address setup time with respect to $\overline{W}$	65		85		100		120		ns
t _{su(S1)}	Chip select 1 setup time	65		85		100		120		ns
t _{su(S2)}	Chip select 2 setup time	65		85		100		120		ns
t _{su(D)}	Data setup time	30		40		45		50		ns
t _{h(D)}	Data hold time	0		0		0		0		ns
t _{rec(W)}	Write recovery time	0		0		0		0		ns
t _{dis(W)}	Output disable time from $\overline{W}$ low		25		35		40		50	ns
t _{dis(OE)}	Output disable time from $\overline{OE}$ high		25		35		40		50	ns
t _{en(W)}	Output enable time from $\overline{W}$ high	5		5		5		5		ns
t _{en(OE)}	Output enable time from $\overline{OE}$ low	5		5		5		5		ns

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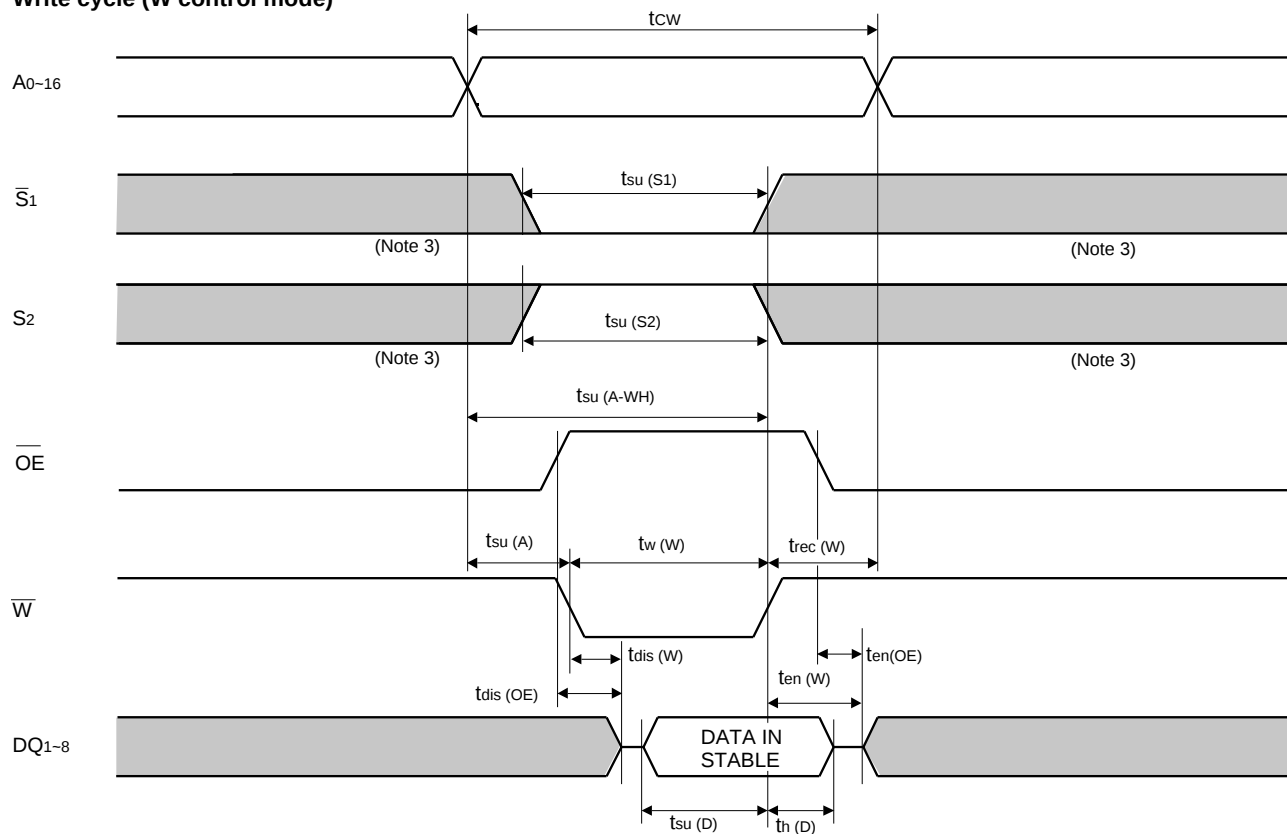
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(4) TIMING DIAGRAMS

Read cycle



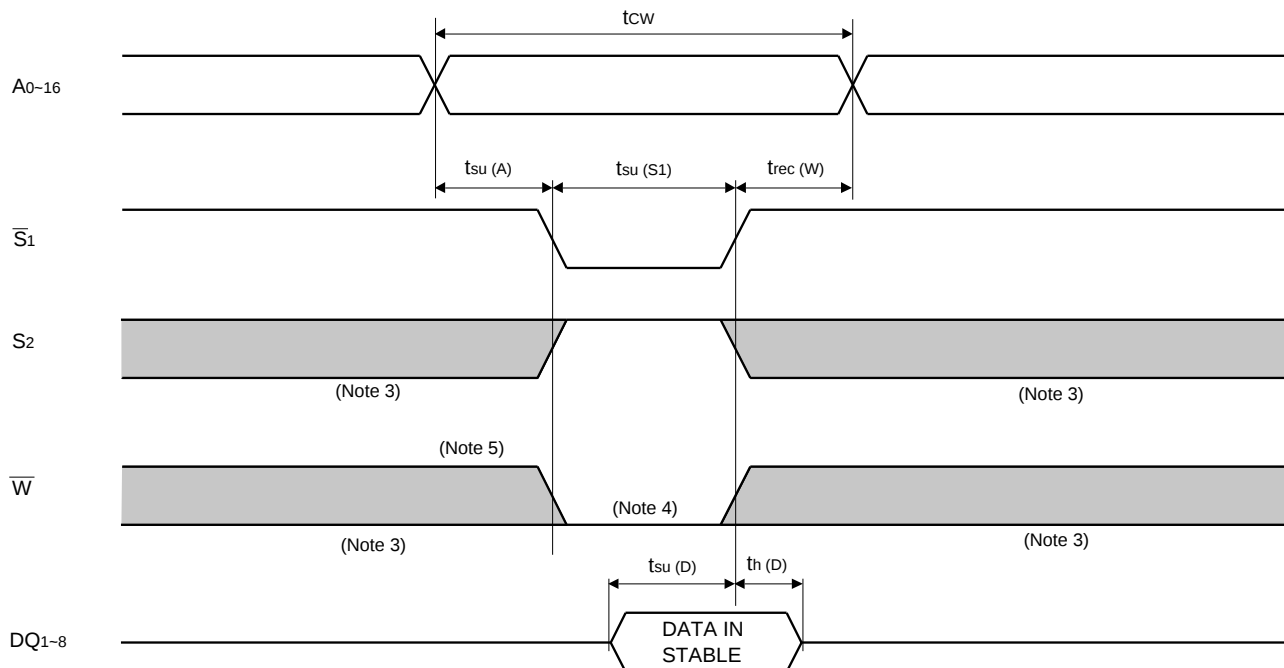
Write cycle ($\overline{W}$ control mode)



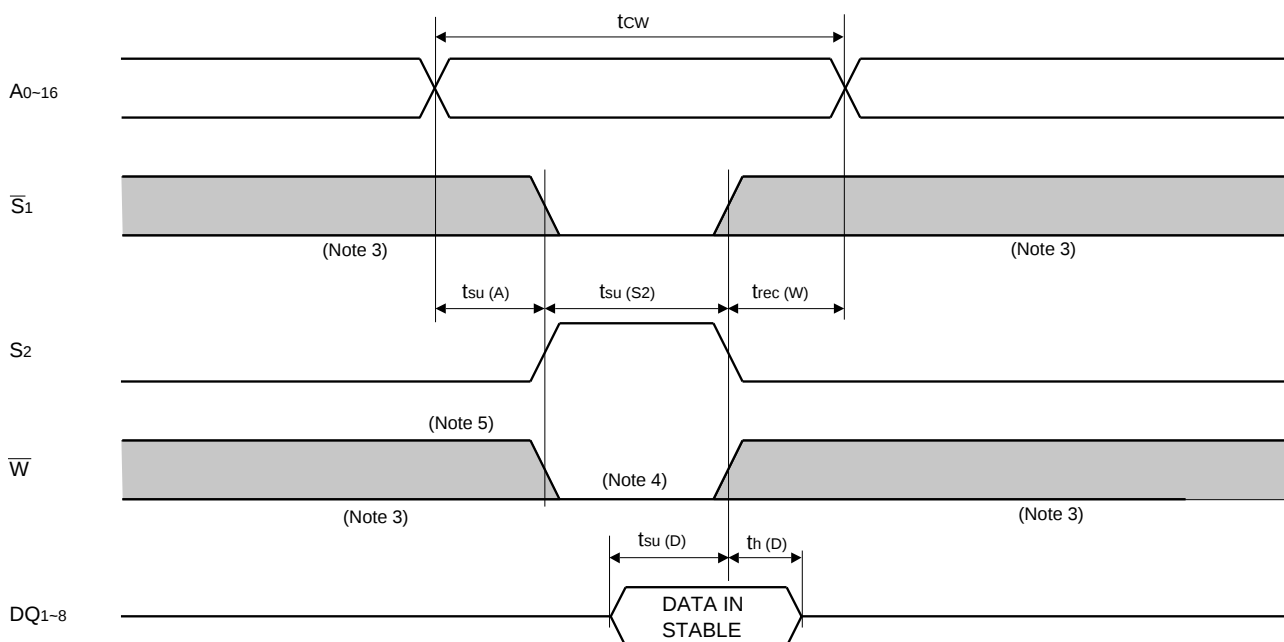
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**M5M51008BFP,VP,RV,KV,KR -70VL,-10VL,-12VL,-15VL,
-70VLL,-10VLL,-12VLL,-15VLL**
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Write cycle ($\overline{S_1}$ control mode)



Write cycle (S_2 control mode)



- Note 3: Hatching indicates the state is "don't care".
 4: Writing is executed while S_2 high overlaps $\overline{S_1}$ and $\overline{W}$ low.
 5: When the falling edge of $\overline{W}$ is simultaneously or prior to the falling edge of $\overline{S_1}$ or rising edge of S_2 , the outputs are maintained in the high impedance state.
 6: Don't apply inverted phase signal externally when DQ pin is output mode.

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POWER DOWN CHARACTERISTICS

(1) ELECTRICAL CHARACTERISTICS (Ta = 0~70°C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
V _{CC} (PD)	Power down supply voltage		2			V
V _I (S1)	Chip select input $\overline{S}_1$		2.0			V
V _I (S2)	Chip select input S ₂				0.2	V
I _{CC} (PD)	Power down supply current	V _{CC} = 3V 1) S ₂ $\leq$ 0.2V, other inputs = 0~3V	-L		50	μ A
		2) $\overline{S}_1 \geq V_{CC} - 0.2V, S_2 \geq V_{CC} - 0.2V$ other inputs = 0~3V	-LL	0.3	10 (Note 7)	

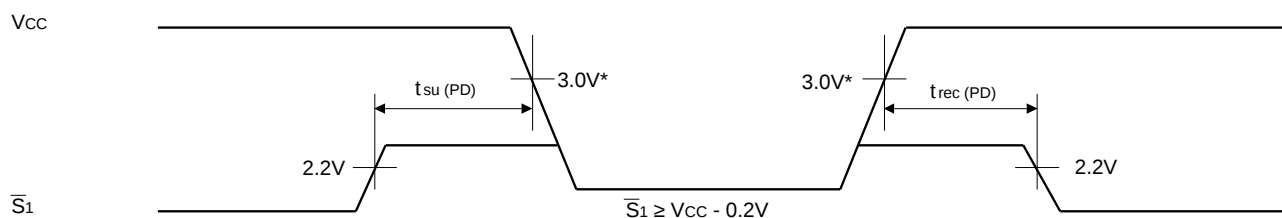
Note7: I_{CC} (PD) = 1 μ A in case of Ta = 25°C

(2) TIMING REQUIREMENTS (Ta = 0~70°C, unless otherwise noted)

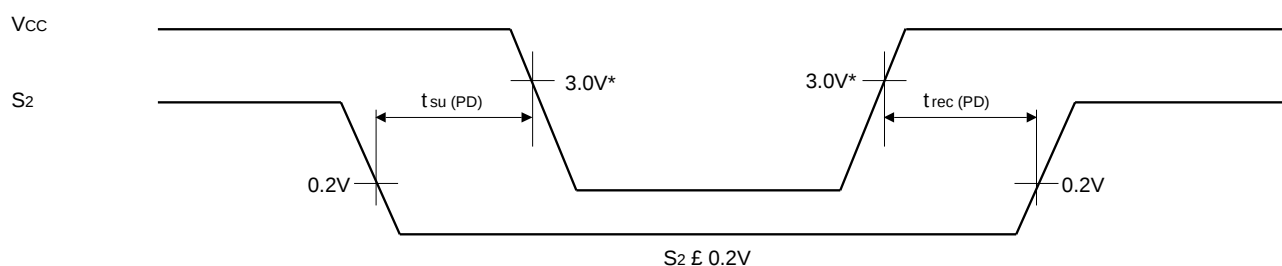
Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
t _{su} (PD)	Power down set up time		0			ns
t _{rec} (PD)	Power down recovery time		5			ms

(3) POWER DOWN CHARACTERISTICS

$\overline{S}_1$ control mode



S₂ control mode



*Note 2.7V(-12VL,-12VLL,-15VL,-15VLL)



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- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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